

Title (en)

METHOD AND DEVICE FOR CASTING NON-FERROUS METAL MELTS, IN PARTICULAR COPPER OR COPPER ALLOYS

Title (de)

VERFAHREN UND VORRICHTUNG ZUM VERGIESSEN VON NE-METALLSCHMELZEN, INSbesondere KUPFER ODER KUPFERLEGIERUNGEN

Title (fr)

PROCÉDÉ ET DISPOSITIF DESTINÉS À LA COULÉE DE BAINS DE FUSION NON FERREUX, EN PARTICULIER DE CUIVRE ET D'ALLIAGES DE CUIVRE

Publication

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Application

EP 08701107 A 20080115

Priority

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- EP 07001253 A 20070120
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Abstract (en)

[origin: EP1946866A1] In a hot metal casting process for copper or copper alloy sheeting of at least 20 mm thickness, molten metal is discharged from a tundish through channels (2) at a defined angle e.g. 9 degrees to the horizontal. The moving molten metal is maintained at a predefined depth (H) within the tundish. The molten metal is maintained at the same level as it passes through a distribution vessel (1) and then passes almost without delivery pressure into the channel. The molten metal then pours uncovered into a hoop mould (3) with flow maintained until reaching the required depth (7). The molten metal flow speed through the discharge channel is limited by a roughened surface or mechanical elements. Hot metal surface vortices are prevented from mould escape by a rim (13). Gases emerging from the molten metal migrate to the void (11) above the hot metal flow.

IPC 8 full level

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